







TEXAS INSTRUMENTS

SN74AUP1G126 SCES596G – JULY 2004–REVISED AUGUST 2017

# SN74AUP1G126 Low-Power Single Bus Buffer Gate With Tri-State Output

## 1 Features

- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22-
  - 2000-V Human-Body Model (A114-B, Class II)
  - 1000-V Charged-Device Model (C101)
- Available in the Texas Instruments NanoStar™ Package
- Low Static-Power Consumption (I<sub>CC</sub> = 0.9 μA Maximum)
- Low Dynamic-Power Consumption (C<sub>pd</sub> = 4 pF Typical at 3.3 V)
- Low Input Capacitance (C<sub>i</sub> = 1.5 pF Typical)
- Low Noise Overshoot and Undershoot  ${<}10\%$  of  $V_{CC}$
- Input-Disable Feature Allows Floating Input Conditions
- Ioff Supports Partial-Power-Down Mode Operation
- Input Hysteresis Allows Slow Input Transition and Better Switching Noise Immunity at Input
- Wide Operating V<sub>CC</sub> Range of 0.8 V to 3.6 V
- Optimized for 3.3-V Operation
- 3.6-V I/O Tolerant to Support Mixed-Mode Signal Operation
- t<sub>pd</sub> = 4.6 ns Maximum at 3.3 V
- Suitable for Point-to-Point Applications

# 2 Applications

- Audio Dock: Portable
- BluRay<sup>™</sup> Players and Home Theaters
- Personal Digital Assistant (PDA)
- Power: Telecom/Server AC/DC Supply: Single Controller: Analog and Digital
- Solid-State Drive (SSD): Client and Enterprise
- TV: LCD/Digital and High-Definition (HDTV)
- Tablet: Enterprise
- Wireless Headsets, Keyboards, and Mice

## **3 Description**

The AUP family is TI's premier solution to the industry's low-power needs in battery-powered portable applications. This family assures a very low static and dynamic power consumption across the entire  $V_{CC}$  range of 0.8 V to 3.6 V, resulting in an increased battery life. This product also maintains excellent signal integrity (see AUP – The Lowest-Power Family and Excellent Signal Integrity).

This bus buffer gate is a single line driver with a 3state output. The output is disabled when the outputenable (OE) input is low. This device has the inputdisable feature, which allows floating input signals.

To assure the high-impedance state during power up or power down, OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

NanoStar<sup>™</sup> package technology is a major breakthrough in IC packaging concepts, using the die as the package.

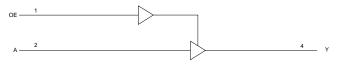
This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs when the device is powered down. This inhibits current backflow into the device which prevents damage to the device.

| PART NUMBER     | PACKAGE     | BODY SIZE (NOM)   |
|-----------------|-------------|-------------------|
| SN74AUP1G126DRL | SOT-5X3 (5) | 1.60 mm × 1.20 mm |
| SN74AUP1G126DBV | SOT-23 (5)  | 1.60 mm × 2.90 mm |
| SN74AUP1G126DCK | SC70 (5)    | 1.25 mm × 2.00 mm |
| SN74AUP1G126DRY | SON (6)     | 1.00 mm × 1.45 mm |
| SN74AUP1G126DSF | SON (6)     | 1.00 mm × 1.00 mm |
| SN74AUP1G126YFP | DSBGA (6)   | 0.76 mm × 1.16 mm |
| SN74AUP1G126YZP | DSBGA (5)   | 0.89 mm × 1.39 mm |
| SN74AUP1G126DPW | X2SON (5)   | 0.80 mm × 0.80 mm |

#### Device Information<sup>(1)</sup>

(1) For all available packages, see the orderable addendum at the end of the data sheet.

## Logic Diagram (Positive Logic)



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## **4** Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

#### Changes from Revision F (May 2010) to Revision G

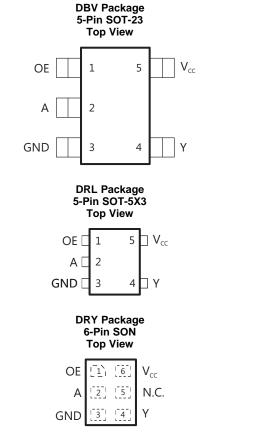
| Page |
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| • | Added Device Information table, Pin Configuration and Functions section, ESD Ratings table, Thermal Information table, Feature Description section, Application and Implementation section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section |
|---|--|
| • | Deleted Ordering Information table, see Mechanical, Packaging, and Orderable Information at the end of the data  |

sheet ...... 1

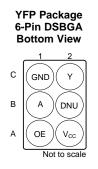


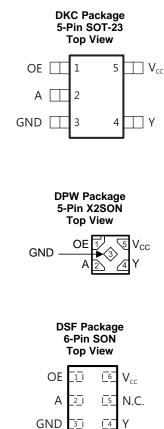
# 5 Pin Configuration and Functions





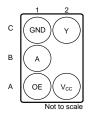
See mechanical drawings for dimensions.







5-Pin DSBGA Bottom View



**Pin Functions** 

| PIN             |                       |             |     |     |     |                             |
|-----------------|-----------------------|-------------|-----|-----|-----|-----------------------------|
| NAME            | DBV, DCK,<br>DRL, DPW | DRY,<br>DSF | YFP | YZP | I/O | DESCRIPTION                 |
| А               | 2                     | 2           | B1  | B1  | I   | Input                       |
| DNU             | —                     | —           | -   | B2  | _   | Do not use                  |
| GND             | 3                     | 3           | C1  | C1  | _   | Ground                      |
| N.C.            | —                     | 5           | B2  | —   | —   | No Internal Connection      |
| OE              | 1                     | 1           | A1  | A1  | I   | Output enable (active high) |
| V <sub>CC</sub> | 5                     | 6           | A2  | A2  | —   | Positive supply             |
| Υ               | 4                     | 4           | C2  | C2  | 0   | Buffered output             |

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## **6** Specifications

## 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |  |   |      | MIN  | MAX                   | UNIT |
|------------------|--|---|------|------|-----------------------|------|
| $V_{CC}$         | Supply voltage   |   |      | -0.5 | 4.6                   | V    |
| VI               | Input voltage <sup>(2)</sup>                                   |   |      | -0.5 | 4.6                   | V    |
| Vo               | Voltage range applied to any output in the high-imped          | ance or power-off state   | 2(2) | -0.5 | 4.6                   | V    |
| Vo               | O Output voltage range in the high or low state <sup>(2)</sup> |   |      |      | V <sub>CC</sub> + 0.5 | V    |
| I <sub>IK</sub>  | Input clamp current  | V <sub>1</sub> < 0  |      |      | -50                   | mA   |
| I <sub>OK</sub>  | Output clamp current   | V <sub>O</sub> < 0  |      |      | -50                   | mA   |
| I <sub>O</sub>   | Continuous output current                                      |   |      |      | ±20                   | mA   |
|                  | Continuous current through V <sub>CC</sub> or GND              |   |      |      | ±50                   | mA   |
| Tj               | Junction Temperature   |   |      |      | 150                   | °C   |
| T <sub>stg</sub> | Storage temperature  | clamp current $V_l < 0$ t clamp current $V_O < 0$ nuous output current $V_O < 0$ nuous current through $V_{CC}$ or GND   on Temperature |      |      |                       | °C   |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

## 6.2 ESD Ratings

|                                     |                         |  | VALUE | UNIT |
|-------------------------------------|-------------------------|--|-------|------|
| V                                   | Electroptotic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | 2000  | V    |
| V <sub>(ESD)</sub> Electrostatic di | Electrostatic discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | 1000  | v    |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

## 6.3 Recommended Operating Conditions

 $See^{(1)}$ 

|                 |                           |   | MIN                  | MAX                  | UNIT |  |  |
|-----------------|---------------------------|---|----------------------|----------------------|------|--|--|
| V <sub>CC</sub> | Supply voltage            |   | 0.8                  | 3.6                  | V    |  |  |
|                 |                           | $V_{CC} = 0.8 V$                            | V <sub>CC</sub>      | 3.6                  |      |  |  |
|                 | Lich lovel input voltogo  | $V_{CC} = 1.1 \text{ V to } 1.95 \text{ V}$ | $0.65 \times V_{CC}$ | 3.6                  | V    |  |  |
| VIH             | High-level input voltage  | $V_{CC}$ = 2.3 V to 2.7 V                   | 1.6                  | 3.6                  | v    |  |  |
|                 |                           | $V_{CC} = 3 V \text{ to } 3.6 V$            | 2                    | 3.6                  |      |  |  |
|                 |                           | $V_{CC} = 0.8 V$                            |                      | 0                    |      |  |  |
| V <sub>IL</sub> | Low-level input voltage   | $V_{CC} = 1.1 \text{ V to } 1.95 \text{ V}$ | 0                    | $0.35 \times V_{CC}$ |      |  |  |
|                 |                           | $V_{CC}$ = 2.3 V to 2.7 V                   | 0                    | 0.7                  | V    |  |  |
|                 |                           | $V_{CC}$ = 3 V to 3.6 V                     | 0                    | 0.9                  |      |  |  |
| V               | Output vieltage           | Active state                                | 0                    | V <sub>CC</sub>      | V    |  |  |
| Vo              | Output voltage            | 3-state                                     | 0                    | 3.6                  | v    |  |  |
|                 |                           | $V_{CC} = 0.8 V$                            |                      | -20                  | μA   |  |  |
|                 |                           | V <sub>CC</sub> = 1.1 V                     |                      | -1.1                 |      |  |  |
|                 |                           | V <sub>CC</sub> = 1.4 V                     |                      | -1.7                 |      |  |  |
| I <sub>OH</sub> | High-level output current | V <sub>CC</sub> = 1.65 V                    |                      | -1.9                 | mA   |  |  |
|                 |                           | $V_{CC} = 2.3 V$                            |                      | -3.1                 |      |  |  |
|                 |                           | $V_{CC} = 3 V$                              |                      | -4                   |      |  |  |

 All unused inputs of the device must be held at V<sub>CC</sub> or GND to assure proper device operation. See Implications of Slow of Floating CMOS Inputs.



## **Recommended Operating Conditions (continued)**

See<sup>(1)</sup>

|                       |   |  | MIN | MAX | UNIT |
|-----------------------|---|--|-----|-----|------|
| I <sub>OL</sub>       |   | $V_{CC} = 0.8 V$                           |     | 20  | μA   |
|                       |   | V <sub>CC</sub> = 1.1 V                    |     | 1.1 |      |
|                       | Low-level output current                      | $V_{CC} = 1.4 V$                           |     | 1.7 |      |
|                       |   | V <sub>CC</sub> = 1.65 V                   |     | 1.9 | mA   |
|                       |   | $V_{CC} = 2.3 V$                           |     | 3.1 |      |
|                       |   | $V_{CC} = 3 V$                             |     | 4   |      |
| $\Delta t / \Delta v$ | Input transition rise or fall rate            | $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$ |     | 200 | ns/V |
| T <sub>A</sub>        | T <sub>A</sub> Operating free-air temperature |  | -40 | 85  | °C   |

## 6.4 Thermal Information

|                               |   | SN74AUP1G126     |                 |               |              |              |                |                |                |      |
|-------------------------------|---|------------------|-----------------|---------------|--------------|--------------|----------------|----------------|----------------|------|
| THERMAL METRIC <sup>(1)</sup> |   | DRL<br>(SOT-5X3) | DBV<br>(SOT-23) | DCK<br>(SC70) | DRY<br>(SON) | DSF<br>(SON) | DPW<br>(X2SON) | YFP<br>(DSBGA) | YZP<br>(DSBGA) | UNIT |
|                               |   | 5 PINS           | 5 PINS          | 5 PINS        | 6 PINS       | 6 PINS       | 5 PINS         | 6 PINS         | 5 PINS         |      |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance        | 295.1            | 230.5           | 303.6         | 342.1        | 377.1        | 504.3          | 125.4          | 146.2          | °C/W |
| $R_{\theta JC(top)}$          | Junction-to-case (top) thermal resistance     | 131.0            | 172.7           | 203.8         | 233.1        | 187.7        | 234.9          | 1.9            | 1.4            | °C/W |
| $R_{\theta J B}$              | Junction-to-board thermal resistance          | 143.9            | 62.2            | 100.9         | 206.7        | 236.6        | 370.3          | 37.2           | 39.3           | °C/W |
| ΨJT                           | Junction-to-top<br>characterization parameter | 14.7             | 49.3            | 76.1          | 63.4         | 29.0         | 44.5           | 0.5            | 0.7            | °C/W |
| ΨJB                           | Junction-to-board characterization parameter  | 144.4            | 61.6            | 99.3          | 206.7        | 236.3        | 369.7          | 37.5           | 39.8           | °C/W |
| R <sub>0JC(bot)</sub>         | Junction-to-case (bottom) thermal resistance  | N/A              | N/A             | N/A           | N/A          | N/A          | 165.2          | N/A            | N/A            | °C/W |

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

## 6.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER       | TEST CON                   | DITIONS                                | V <sub>cc</sub> | MIN                    | ТҮР | MAX    | UNIT |
|-----------------|----------------------------|--|-----------------|------------------------|-----|--------|------|
|                 | L _ 20 uA                  | $T_A = 25^{\circ}C$                    | 0.8 V to 3.6 V  | V <sub>CC</sub> – 0.1  |     | (P MAX |      |
|                 | I <sub>OH</sub> = −20 μA   | $T_A = -40^{\circ}C$ to +85°C          | 0.8 V 10 3.8 V  | $V_{CC} - 0.1$         |     |        |      |
|                 | I <sub>OH</sub> = -1.1 mA  | $T_A = 25^{\circ}C$                    | 1.1 V           | 0.75 × V <sub>CC</sub> |     |        |      |
|                 | $I_{OH} = -1.1 \text{ mA}$ | $T_A = -40^{\circ}C$ to +85°C          | 1.1 V           | $0.7 \times V_{CC}$    |     |        |      |
|                 | L _ 17m                    | $T_A = 25^{\circ}C$                    | 1.4 V           | 1.11                   |     |        |      |
|                 | I <sub>OH</sub> = -1.7 mA  | $T_A = -40^{\circ}C$ to +85°C          | 1.4 V           | 1.03                   |     |        |      |
|                 | L _ 10 mA                  | $T_A = 25^{\circ}C$                    | 1.65 V          | 1.32                   |     |        |      |
| V               | I <sub>OH</sub> = -1.9 mA  | $T_A = -40^{\circ}C$ to +85°C          | 1.05 V          | 1.3                    |     |        | V    |
| V <sub>OH</sub> | L _ 22mA                   | $T_A = 25^{\circ}C$                    |                 | 2.05                   |     |        | v    |
|                 | I <sub>OH</sub> = -2.3 mA  | $T_A = -40^{\circ}C$ to +85°C          | 2.3 V           | 1.97                   |     |        |      |
|                 | L 21 m A                   | $T_A = 25^{\circ}C$                    | 2.3 V           | 1.9                    |     |        |      |
|                 | I <sub>OH</sub> = -3.1 mA  | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ |                 | 1.85                   |     |        |      |
|                 | L _ 27mA                   | $T_A = 25^{\circ}C$                    |                 | 2.72                   |     |        |      |
|                 | I <sub>OH</sub> = -2.7 mA  | $T_A = -40^{\circ}C$ to +85°C          | 3 V             | 2.67                   |     |        |      |
|                 | L _ 4 m 4                  | $T_A = 25^{\circ}C$                    | 5 V             | 2.6                    |     |        |      |
|                 | $I_{OH} = -4 \text{ mA}$   | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ |                 | 2.55                   |     |        |      |



# **Electrical Characteristics (continued)**

| over recommended o | perating free-air | temperature range | (unless otherwise noted) |
|--------------------|-------------------|-------------------|--------------------------|
|                    | poraling noo an   |                   |                          |

| PAI              | RAMETER   | TEST CON   | DITIONS                                | V <sub>cc</sub> | MIN  | TYP MAX               |    |  |
|------------------|---|--|--|-----------------|------|-----------------------|----|--|
|                  |   | 1 00.01  | $T_A = 25^{\circ}C$                    | 0.0.1/1-0.0.1/  |      | 0.1                   |    |  |
|                  |   | I <sub>OL</sub> = 20 μΑ  | $T_A = -40^{\circ}C$ to +85°C          | 0.8 V to 3.6 V  |      | 0.1                   |    |  |
|                  |   | 1 11   | T <sub>A</sub> = 25°C                  | 4.4.1/          |      | 0.3 × V <sub>CC</sub> | ;  |  |
|                  |   | I <sub>OL</sub> = 1.1 mA   | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 1.1 V           |      | 0.3 × V <sub>CC</sub> | :  |  |
|                  |   |  | T <sub>A</sub> = 25°C                  | 4.434           | 0.31 |                       |    |  |
|                  |   | I <sub>OL</sub> = 1.7 mA   | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 1.4 V           | 0.37 |                       |    |  |
|                  |   |  | T <sub>A</sub> = 25°C                  | 4.05.1/         |      |                       |    |  |
| . ,              | I <sub>OL</sub> = 1.9 mA  |  | $T_A = -40^{\circ}C$ to +85°C          | 1.65 V          |      | 0.35                  |    |  |
| V <sub>OL</sub>  |   |  | T <sub>A</sub> = 25°C                  |                 |      | 0.31                  | V  |  |
|                  |   | I <sub>OL</sub> = 2.3 mA   | $T_A = -40^{\circ}C$ to +85°C          |                 |      | 0.33                  |    |  |
|                  |   |  | $T_A = 25^{\circ}C$                    | 2.3 V           |      | 0.44                  |    |  |
|                  |   | I <sub>OL</sub> = 3.1 mA   | $T_A = -40^{\circ}C$ to +85°C          |                 |      | 0.45                  |    |  |
|                  |   |  | $T_A = 25^{\circ}C$                    |                 |      | 0.31                  |    |  |
|                  |   | I <sub>OL</sub> = 2.7 mA   | $T_A = -40^{\circ}C$ to +85°C          |                 |      | 0.33                  |    |  |
|                  |   |  | T <sub>A</sub> = 25°C                  | 3 V             |      | 0.44                  |    |  |
|                  |   | $I_{OL} = 4 \text{ mA}$  | $T_A = -40^{\circ}C$ to +85°C          |                 |      | 0.45                  |    |  |
|                  | A or OE   |  | $T_A = 25^{\circ}C$                    |                 |      | 0.1                   |    |  |
| 1                | input   | $V_I = GND$ to 3.6 V   | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 0 V to 3.6 V    |      | 0.5                   | μA |  |
|                  |   |  | T <sub>A</sub> = 25°C                  | 0.14            | 0.   |                       |    |  |
| off              |   | $V_{\rm I}$ or $V_{\rm O}$ = 0 V to 3.6 V                        | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 0 V             |      | 0.6                   | μA |  |
|                  |   |  | $T_A = 25^{\circ}C$                    | 0.1/15 0.0.1/   |      | 0.2                   |    |  |
| $\Delta I_{off}$ |   | $V_{\rm I}$ or $V_{\rm O}$ = 0 V to 3.6 V                        | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 0 V to 0.2 V    |      | 0.6                   | μA |  |
| oz               |   | $V_{O} = V_{CC}$ or GND, $T_{A} = -40^{\circ}$                   | °C to +85°C                            | 3.6 V           |      | 0.5                   | μA |  |
|                  |   | $V_{I} = GND \text{ or } (V_{CC} \text{ to } 3.6 \text{ V}),$    | T <sub>A</sub> = 25°C                  | 0.0.1/1-0.0.1/  |      | 0.5                   |    |  |
| сс               |   | $OE = GND, I_O = 0$  | $T_A = -40^{\circ}C$ to +85°C          | 0.8 V to 3.6 V  |      | 0.9                   | μA |  |
|                  | A :   |  | T <sub>A</sub> = 25°C                  |                 |      | 40                    | )  |  |
|                  | A input   | $V_{I} = V_{CC} - 0.6 V^{(1)}$                                   | $T_A = -40^{\circ}C$ to +85°C          | 0.01/           |      | 50                    | )  |  |
|                  | $I_0 = 0$   | T <sub>A</sub> = 25°C  | 3.3 V                                  |                 | 110  | μA                    |    |  |
| ∆l <sub>CC</sub> | $\begin{array}{ c c c c c } \hline OE \text{ input} \\ \hline \\ All \text{ inputs} \\ \hline \\ OE = V_{CC} \\ \hline \\ \\ CE \\ \hline \\ \\ CE \\ \hline \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ $ |  | $T_A = -40^{\circ}C$ to +85°C          |                 |      | 120                   |    |  |
|                  |   |  | T <sub>A</sub> = −40°C to +85°C        | 0.8 V to 3.6 V  |      | C                     |    |  |
| <u>~</u>         |   |  |  | 0 V             |      | 1.5                   | pF |  |
| Ci               | $V_1 = V_{CC}$ or GND, $T_A = 25^{\circ}C$  |  |  | 3.6 V           |      |                       |    |  |
| Co               |   | $V_{\rm O} = V_{\rm CC}$ or GND, $T_{\rm A} = 25^{\circ}{\rm C}$ | 2                                      | 3.6 V           |      | 3                     | pF |  |

 $\begin{array}{ll} \mbox{(1)} & \mbox{One input at } V_{CC} - 0.6 \ \mbox{V}, \mbox{ other input at } V_{CC} \ \mbox{or GND} \\ \mbox{(2)} & \mbox{To show } I_{CC} \ \mbox{is very low when the input-disable feature is enabled} \end{array}$ 



# 6.6 Switching Characteristics: $C_L = 5 \text{ pF}$

over recommended operating free-air temperature range,  $C_L = 5 \text{ pF}$  (unless otherwise noted) (see Figure 2 and Figure 3)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CC                                     | ONDITIONS                                     | MIN | ТҮР  | MAX  | UNIT |
|------------------|-----------------|----------------|---|---|-----|------|------|------|
|                  |                 |                | V <sub>CC</sub> = 0.8 V                     | T <sub>A</sub> = 25°C                         |     | 18.1 |      |      |
|                  |                 |                | 1011.0411                                   | T <sub>A</sub> = 25°C                         | 4.3 | 7.4  | 12.6 |      |
|                  |                 |                | $V_{CC} = 1.2 V \pm 0.1 V$                  | $T_A = -40^{\circ}C$ to +85°C                 | 2.7 |      | 15.3 |      |
|                  |                 |                |   | $T_A = 25^{\circ}C$                           | 3.3 | 5.2  | 8.5  |      |
|                  |                 |                | $V_{CC} = 1.5 V \pm 0.1 V$                  | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 1   |      | 10.2 |      |
| t <sub>pd</sub>  | А               | Y              |   | T <sub>A</sub> = 25°C                         | 2.6 | 4.1  | 6.8  | ns   |
|                  |                 |                | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 1.3 |      | 8.3  |      |
|                  |                 |                | V 05V 00V                                   | T <sub>A</sub> = 25°C                         | 2   | 2.9  | 4.7  |      |
|                  |                 |                | $V_{CC} = 2.5 V \pm 0.2 V$                  | $T_A = -40^{\circ}C$ to +85°C                 | 1.1 |      | 5.8  |      |
|                  |                 |                | <u> </u>                                    | T <sub>A</sub> = 25°C                         | 1.7 | 2.4  | 3.8  |      |
|                  |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 1   |      | 4.6  |      |
|                  |                 |                | V <sub>CC</sub> = 0.8 V                     | T <sub>A</sub> = 25°C                         |     | 19.1 |      |      |
|                  |                 |                | 1011.0411                                   | $T_A = 25^{\circ}C$                           | 5.1 | 9.3  | 15.9 | ns   |
|                  |                 |                | $V_{CC} = 1.2 V \pm 0.1 V$                  | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 3.6 |      | 19.2 |      |
|                  |                 |                | $V_{CC} = 1.5 V \pm 0.1 V$                  | $T_A = 25^{\circ}C$                           | 4.1 | 6.6  | 10.5 |      |
|                  | OE              | Y              |   | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 2.5 |      | 12.7 |      |
| t <sub>en</sub>  |                 |                | V 1.0.V . 0.45.V                            | T <sub>A</sub> = 25°C                         | 3.2 | 5.3  | 8.7  |      |
|                  |                 |                | $V_{CC} = 1.8 V \pm 0.15 V$                 | $T_A = -40^{\circ}C$ to +85°C                 | 2.1 |      | 10.3 |      |
|                  |                 |                | $V_{CC} = 2.5 V \pm 0.2 V$                  | $T_A = 25^{\circ}C$                           | 2.5 | 3.8  | 6    |      |
|                  |                 |                | $V_{\rm CC} = 2.5 \ V \pm 0.2 \ V$          | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 1.6 |      | 7.2  |      |
|                  |                 |                | V 22V 02V                                   | $T_A = 25^{\circ}C$                           | 2.1 | 3.2  | 4.9  |      |
|                  |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 1.4 |      | 5.9  |      |
|                  |                 |                | $V_{CC} = 0.8 V$                            | $T_A = 25^{\circ}C$                           |     | 12.1 |      |      |
|                  |                 |                | 1011.011                                    | $T_A = 25^{\circ}C$                           | 2.4 | 4.1  | 6.9  |      |
|                  |                 |                | $V_{CC} = 1.2 V \pm 0.1 V$                  | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 2.2 |      | 7.7  |      |
|                  |                 |                |   | $T_A = 25^{\circ}C$                           | 1.8 | 2.9  | 4.5  |      |
|                  |                 |                | $V_{CC} = 1.5 V \pm 0.1 V$                  | $T_A = -40^{\circ}C$ to +85°C                 | 1.7 |      | 5.1  |      |
| t <sub>dis</sub> | OE              | Y              |   | T <sub>A</sub> = 25°C                         | 1   | 2.9  | 4.3  | ns   |
|                  |                 |                | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 1.5 |      | 4.7  | -    |
|                  |                 |                |   | T <sub>A</sub> = 25°C                         | 1   | 1.8  | 2.7  |      |
|                  |                 |                | $V_{CC} = 2.5 V \pm 0.2 V$                  | $T_A = -40^{\circ}C$ to +85°C                 | 1   |      | 3.3  |      |
|                  |                 | V              | V 0.0.V 0.0.V                               | T <sub>A</sub> = 25°C                         | 1.2 | 2.2  | 3.2  |      |
|                  |                 |                | $V_{CC} = 3.3 V \pm 0.3 V$                  | $T_A = -40^{\circ}C$ to +85°C                 | 1.1 |      | 4    |      |

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# 6.7 Switching Characteristics: $C_L = 10 \text{ pF}$

over recommended operating free-air temperature range,  $C_L = 10 \text{ pF}$  (unless otherwise noted) (see Figure 2 and Figure 3)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST C                                      | ONDITIONS                                     | MIN | ТҮР  | МАХ  | UNIT        |
|------------------|-----------------|----------------|---|---|-----|------|------|-------------|
|                  |                 |                | V <sub>CC</sub> = 0.8 V                     | T <sub>A</sub> = 25°C                         |     | 20.5 | 13.7 |             |
|                  |                 |                |   | T <sub>A</sub> = 25°C                         | 4.6 | 8.4  | 9.3  |             |
|                  |                 |                | $V_{CC} = 1.2 V \pm 0.1 V$                  | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 3.6 |      | 16.6 |             |
|                  |                 |                |   | T <sub>A</sub> = 25°C                         | 3.5 | 5.9  | 7.5  |             |
|                  |                 |                | $V_{CC} = 1.5 V \pm 0.1 V$                  | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 2.4 |      | 11.1 |             |
| t <sub>pd</sub>  | A or B          | Y              |   | T <sub>A</sub> = 25°C                         | 3.9 | 4.7  | 5.3  | ns          |
|                  |                 |                | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | $T_A = -40^{\circ}C$ to +85°C                 | 1.3 |      | 9.1  |             |
|                  |                 |                | V 05V 00V                                   | T <sub>A</sub> = 25°C                         | 2.3 | 3.4  | 4.3  |             |
|                  |                 |                | $V_{CC} = 2.5 V \pm 0.2 V$                  | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 1.6 |      | 6.4  |             |
|                  |                 |                | V 22V 02V                                   | $T_A = 25^{\circ}C$                           | 2.1 | 2.8  |      |             |
|                  |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 1.4 |      | 5.2  |             |
|                  |                 |                | V <sub>CC</sub> = 0.8 V                     | T <sub>A</sub> = 25°C                         |     | 21.8 | 16.8 |             |
|                  |                 |                |   | T <sub>A</sub> = 25°C                         | 4.9 | 10.2 | 11.2 | 2<br>2<br>5 |
|                  |                 |                | $V_{CC} = 1.2 V \pm 0.1 V$                  | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 4.4 |      | 20.2 |             |
|                  |                 |                |   | $T_A = 25^{\circ}C$                           | 3.9 | 7.3  | 9.2  |             |
|                  | OE              |                | $V_{CC} = 1.5 V \pm 0.1 V$                  | $T_A = -40^{\circ}C$ to +85°C                 | 3.3 |      | 13.5 |             |
| t <sub>en</sub>  |                 | Y              | V <sub>CC</sub> = 1.8 V ± 0.15 V            | $T_A = 25^{\circ}C$                           | 3.4 | 5.8  | 6.4  |             |
|                  |                 |                | $v_{\rm CC} = 1.8 \ v \pm 0.15 \ v$         | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 2.7 |      | 11   |             |
|                  |                 |                | V <sub>CC</sub> = 2.5 V ± 0.2 V             | $T_A = 25^{\circ}C$                           | 2.5 | 4.3  | 5.4  | ]           |
|                  |                 |                | $v_{\rm CC} = 2.5 \ v \pm 0.2 \ v$          | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 2.1 |      | 7.8  |             |
|                  |                 |                | V 22V 02V                                   | $T_A = 25^{\circ}C$                           | 2.1 | 3.7  |      |             |
|                  |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  | $T_A = -40^{\circ}C$ to +85°C                 | 1.9 |      | 6.4  |             |
|                  |                 |                | V <sub>CC</sub> = 0.8 V                     | $T_A = 25^{\circ}C$                           |     | 13   |      |             |
|                  |                 |                | V 10V 01V                                   | $T_A = 25^{\circ}C$                           | 3.8 | 6.6  | 11.7 |             |
|                  |                 |                | $V_{CC} = 1.2 V \pm 0.1 V$                  | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 1.2 |      | 14   |             |
|                  |                 |                |   | $T_A = 25^{\circ}C$                           | 2.2 | 4.7  | 7.9  |             |
|                  |                 |                | $V_{CC} = 1.5 V \pm 0.1 V$                  | $T_A = -40^{\circ}C$ to +85°C                 | 1.3 |      | 9.3  |             |
| t <sub>dis</sub> | OE              | Y              | 101/0451                                    | $T_A = 25^{\circ}C$                           | 2.4 | 4.4  | 6.4  | ns          |
|                  |                 |                | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 2.2 |      | 7.5  | 5<br>9<br>4 |
|                  |                 |                |   | $T_A = 25^{\circ}C$                           | 1.3 | 3.1  | 4.9  |             |
|                  |                 |                | $V_{CC} = 2.5 V \pm 0.2 V$                  | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 1.2 |      | 5.4  |             |
|                  |                 |                | V 0.0.V . 0.0.V                             | T <sub>A</sub> = 25°C                         | 1.9 | 3.4  | 5    |             |
|                  |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 1.9 |      | 5.6  |             |



# 6.8 Switching Characteristics: C<sub>L</sub> = 15 pF

over recommended operating free-air temperature range,  $C_L = 15 \text{ pF}$  (unless otherwise noted) (see Figure 2 and Figure 3)

| PARAMETER       | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST C                                     | ONDITIONS                                     | MIN | ТҮР  | МАХ  | UNIT |
|-----------------|-----------------|----------------|--|---|-----|------|------|------|
|                 |                 |                | V <sub>CC</sub> = 0.8 V                    | T <sub>A</sub> = 25°C                         |     | 22.5 |      |      |
|                 |                 |                | 1011.041                                   | T <sub>A</sub> = 25°C                         | 5.8 | 9.3  | 15.1 |      |
|                 |                 |                | $V_{CC} = 1.2 V \pm 0.1 V$                 | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 4.3 |      | 17.9 |      |
|                 |                 |                |  | $T_A = 25^{\circ}C$                           | 4.4 | 6.6  | 10.2 |      |
|                 |                 |                | $V_{CC} = 1.5 V \pm 0.1 V$                 | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 3   |      | 12.1 |      |
| t <sub>pd</sub> | A or B          | Y              | V <sub>CC</sub> = 1.8 V ± 0.15 V           | $T_A = 25^{\circ}C$                           | 3.5 | 5.3  | 8.3  | ns   |
|                 |                 |                | $v_{\rm CC} = 1.0 \ v \pm 0.15 \ v$        | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 2.3 |      | 9.9  |      |
|                 |                 |                | V 25V 02V                                  | $T_A = 25^{\circ}C$                           | 2.7 | 3.9  | 5.8  |      |
|                 |                 |                | $V_{CC} = 2.5 V \pm 0.2 V$                 | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 1.9 |      | 7    |      |
|                 |                 |                | $V_{CC} = 3.3 V \pm 0.3 V$                 | $T_A = 25^{\circ}C$                           | 2.4 | 3.2  | 4.7  |      |
|                 |                 |                | $v_{\rm CC} = 3.3 \ v \pm 0.3 \ v$         | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 1.8 |      | 5.7  |      |
|                 |                 |                | $V_{CC} = 0.8 V$                           | $T_A = 25^{\circ}C$                           |     | 25.2 |      |      |
|                 |                 |                | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$ | $T_A = 25^{\circ}C$                           | 7   | 11.3 | 18.1 |      |
|                 | OE              |                | VCC = 1.2 V ± 0.1 V                        | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 5.4 |      | 21.4 | ns   |
|                 |                 |                | $V_{CC} = 1.5 V \pm 0.1 V$                 | $T_A = 25^{\circ}C$                           | 5.5 | 8.1  | 12.2 |      |
|                 |                 |                | V <sub>CC</sub> = 1.5 V ± 0.1 V            | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 4.1 |      | 14.5 |      |
| en              |                 | Y              | V <sub>CC</sub> = 1.8 V ± 0.15 V           | $T_A = 25^{\circ}C$                           | 4.3 | 6.5  | 10.1 |      |
|                 |                 |                | V <sub>CC</sub> = 1.0 V ± 0.15 V           | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 3.3 |      | 12   |      |
|                 |                 |                | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ | $T_A = 25^{\circ}C$                           | 3.4 | 4.8  | 7.1  | -    |
|                 |                 |                |  | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 2.6 |      | 8.4  |      |
|                 |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | $T_A = 25^{\circ}C$                           | 2.9 | 4.1  | 5.9  |      |
|                 |                 |                | V <sub>CC</sub> = 3.5 V ± 0.5 V            | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 2.3 |      | 6.9  |      |
|                 |                 |                | $V_{CC} = 0.8 V$                           | $T_A = 25^{\circ}C$                           |     | 14   |      |      |
|                 |                 |                | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$ | $T_A = 25^{\circ}C$                           | 3.7 | 5.8  | 8.2  |      |
|                 |                 |                | VCC = 1.2 V ± 0.1 V                        | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 3.3 |      | 11   |      |
|                 |                 |                | $V_{CC} = 1.5 V \pm 0.1 V$                 | $T_A = 25^{\circ}C$                           | 5.5 | 3.9  | 5.9  |      |
|                 |                 |                | V <sub>CC</sub> = 1.5 V ± 0.1 V            | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 2.1 |      | 8    |      |
| dis             | OE              | Y              | V <sub>CC</sub> = 1.8 V ± 0.15 V           | $T_A = 25^{\circ}C$                           | 3.3 | 4.5  | 6.6  | ns   |
|                 |                 |                | $v_{\rm CC} = 1.0 \ v \pm 0.10 \ v$        | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 2.9 |      | 7.4  |      |
|                 |                 |                | $V_{CC} = 2.5 V \pm 0.2 V$                 | $T_A = 25^{\circ}C$                           | 2.3 | 3.2  | 4.3  | 1    |
|                 |                 | V              | $v_{\rm CC} = 2.3 \ v \pm 0.2 \ v$         | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 1.8 |      | 5.1  |      |
|                 |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | T <sub>A</sub> = 25°C                         | 2.4 | 4.8  | 6.2  |      |
|                 |                 |                | $v_{\rm CC} = 3.3 \ v \pm 0.3 \ v$         | $T_A = -40^{\circ}C$ to $+85^{\circ}C$        | 3.1 |      | 6.7  |      |

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# 6.9 Switching Characteristics: C<sub>L</sub> = 30 pF

over recommended operating free-air temperature range,  $C_L = 30 \text{ pF}$  (unless otherwise noted) (see Figure 2 and Figure 3)

| PARAMETER       | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST C                                     | ONDITIONS                              | MIN | ТҮР  | МАХ  | UNIT                  |
|-----------------|-----------------|----------------|--|--|-----|------|------|-----------------------|
|                 |                 |                | V <sub>CC</sub> = 0.8 V                    | T <sub>A</sub> = 25°C                  |     | 29   |      |                       |
|                 |                 |                | V 40V 04V                                  | T <sub>A</sub> = 25°C                  | 7.4 | 12   | 18.7 |                       |
|                 |                 |                | $V_{CC} = 1.2 V \pm 0.1 V$                 | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 6.6 |      | 21.4 |                       |
|                 |                 |                | V 4 E V - 0 4 V                            | $T_A = 25^{\circ}C$                    | 5.7 | 8.6  | 12.5 |                       |
|                 |                 |                | $V_{CC} = 1.5 V \pm 0.1 V$                 | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 4.9 |      | 14.7 |                       |
| t <sub>pd</sub> | A or B          | Y              | V <sub>CC</sub> = 1.8 V ± 0.15 V           | $T_A = 25^{\circ}C$                    | 4.8 | 6.9  | 10.1 | ns                    |
|                 |                 |                | $v_{\rm CC} = 1.8 \ v \pm 0.13 \ v$        | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 3.1 |      | 12   |                       |
|                 |                 |                | V <sub>CC</sub> = 2.5 V ± 0.2 V            | $T_A = 25^{\circ}C$                    | 3.9 | 5.1  | 7.2  |                       |
|                 |                 |                | $v_{\rm CC} = 2.5 \ v \pm 0.2 \ v$         | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 3.3 |      | 8.7  |                       |
|                 |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | $T_A = 25^{\circ}C$                    | 3.5 | 4.8  | 6    |                       |
|                 |                 |                | $v_{\rm CC} = 5.3 \ v \pm 0.3 \ v$         | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 3   |      | 7    |                       |
|                 |                 |                | V <sub>CC</sub> = 0.8 V                    | $T_A = 25^{\circ}C$                    |     | 33.4 |      |                       |
|                 |                 |                | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$ | $T_A = 25^{\circ}C$                    | 8.8 | 14.1 | 21.8 | -<br>-<br>-<br>-<br>- |
|                 |                 |                | $v_{\rm CC} = 1.2 \ v \pm 0.1 \ v$         | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 7.4 |      | 25.5 |                       |
|                 |                 |                | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$ | $T_A = 25^{\circ}C$                    | 6.9 | 10.1 | 14.6 |                       |
|                 | OE              | Y              |  | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 5.6 |      | 17.4 |                       |
| en              |                 |                | V <sub>CC</sub> = 1.8 V ± 0.15 V           | $T_A = 25^{\circ}C$                    | 5.6 | 8.1  | 12   |                       |
|                 |                 |                | VCC = 1.0 V ± 0.10 V                       | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 4.7 |      | 14.1 |                       |
|                 |                 |                | $V_{CC} = 2.5 V \pm 0.2 V$                 | $T_A = 25^{\circ}C$                    | 4.3 | 6.1  | 8.5  |                       |
|                 |                 |                | $v_{\rm CC} = 2.3 \ v \pm 0.2 \ v$         | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 3.8 |      | 10   |                       |
|                 |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | $T_A = 25^{\circ}C$                    | 3.7 | 5.2  | 7.1  |                       |
|                 |                 |                | V <sub>CC</sub> = 5.5 V ± 0.5 V            | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 3.4 |      | 8.3  |                       |
|                 |                 |                | V <sub>CC</sub> = 0.8 V                    | $T_A = 25^{\circ}C$                    |     | 17.7 |      |                       |
|                 |                 |                | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$ | $T_A = 25^{\circ}C$                    | 5.8 | 10   | 16   |                       |
|                 |                 |                | $v_{\rm CC} = 1.2 \ v \pm 0.1 \ v$         | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 3.7 |      | 16   |                       |
|                 |                 |                | V <sub>CC</sub> = 1.5 V ± 0.1 V            | $T_A = 25^{\circ}C$                    | 5.7 | 7.7  | 10.9 |                       |
|                 |                 |                | $v_{\rm CC} = 1.5 \ v \pm 0.1 \ v$         | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 1   |      | 10.7 |                       |
| dis             | OE              | Y              |  | $T_A = 25^{\circ}C$                    | 4.5 | 7.7  | 9.8  | ns                    |
|                 |                 |                | $V_{CC} = 1.8 V \pm 0.15 V$                | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 4.4 |      | 12.5 | -                     |
|                 |                 |                |  | $T_A = 25^{\circ}C$                    | 3.9 | 5.6  | 7.4  |                       |
|                 |                 |                | $V_{CC} = 2.5 V \pm 0.2 V$                 | $T_A = -40^{\circ}C$ to +85°C          | 3.2 |      | 9    | -                     |
|                 |                 |                | V _ 2 2 V · 0 2 V                          | $T_A = 25^{\circ}C$                    | 3.3 | 8.4  | 10.7 |                       |
|                 |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 6.6 |      | 10.8 |                       |



# 6.10 Operating Characteristics

 $T_{A} = 25^{\circ}C$ 

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|                 | PARAMETER                        |                 | TEST CONDITIONS | V <sub>cc</sub>                   | TYP | UNIT |
|-----------------|----------------------------------|-----------------|-----------------|-----------------------------------|-----|------|
|                 |                                  |                 |                 | 0.8 V                             | 3.8 |      |
|                 |                                  |                 |                 | 1.2 V ± 0.1 V                     | 3.7 |      |
|                 | Output apphlad                   | £ 10 MU-        | 1.5 V ±0.1 V    | 3.7                               |     |      |
|                 | Output enabled                   | f = 10 MHz      | 1.8 V ± 0.15 V  | 3.7                               |     |      |
|                 |                                  |                 | 2.5 V ± 0.2 V   | 3.9                               |     |      |
|                 |                                  |                 |                 | $3.3 \text{ V} \pm 0.3 \text{ V}$ | 4   |      |
| C <sub>pd</sub> | Power dissipation<br>capacitance |                 |                 | 0.8 V                             | 0   | pF   |
|                 | oupuonanoe                       |                 |                 | 1.2 V ± 0.1 V                     | 0   |      |
|                 |                                  |                 |                 | 1.5 V ±0.1 V                      | 0   |      |
|                 |                                  | Output disabled | f = 10 MHz      | 1.8 V ± 0.15 V                    | 0   |      |
|                 |                                  |                 | 2.5 V ± 0.2 V   | 0                                 | 1   |      |
|                 |                                  |                 | 2.5 V ± 0.2 V   | 0                                 | 1   |      |
|                 |                                  |                 | 3.3 V ± 0.3 V   | 0                                 | 1   |      |

## 6.11 Typical Characteristics

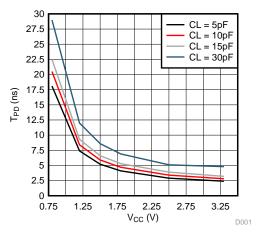


Figure 1. Propagation Delay vs. Supply Voltage and Load Capacitance

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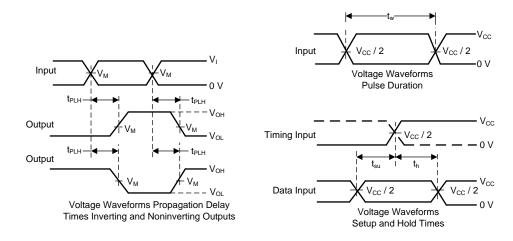
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## 7 Parameter Measurement Information

## 7.1 (Propagation Delays, Setup and Hold Times, and Pulse Width)

From Output Under Test 1 MΩ C (See Note A) Load Circut

|                | $V_{CC} = 0.8 V$    | V <sub>CC</sub> = 1.2 V<br>± 0.1 V | V <sub>CC</sub> = 1.5 V<br>± 0.1 V | V <sub>CC</sub> = 1.8 V<br>± 0.15 V | V <sub>CC</sub> = 2.5 V<br>± 0.2 V | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |
|----------------|---------------------|------------------------------------|------------------------------------|-------------------------------------|------------------------------------|------------------------------------|
| C <sub>L</sub> | 5, 10, 15, 30 pF    | 5, 10, 15, 30 pF                   | 5, 10, 15, 30 pF                   | 5, 10, 15, 30 pF                    | 5, 10, 15, 30 pF                   | 5, 10, 15, 30 pF                   |
| V <sub>M</sub> | V <sub>CC</sub> / 2 | V <sub>CC</sub> / 2                | V <sub>CC</sub> / 2                | V <sub>CC</sub> / 2                 | V <sub>CC</sub> / 2                | V <sub>CC</sub> / 2                |
| V <sub>I</sub> | V <sub>CC</sub>     | V <sub>CC</sub>                    | V <sub>CC</sub>                    | V <sub>CC</sub>                     | V <sub>CC</sub>                    | V <sub>CC</sub>                    |



Notes:

A. C<sub>L</sub> includes probe and jig capacitance. B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>0</sub> = 50  $\Omega$ , t<sub>r</sub> / t<sub>f</sub> = 3 ns.

C. The outputs are measured one at a time, with one transition per measurement.

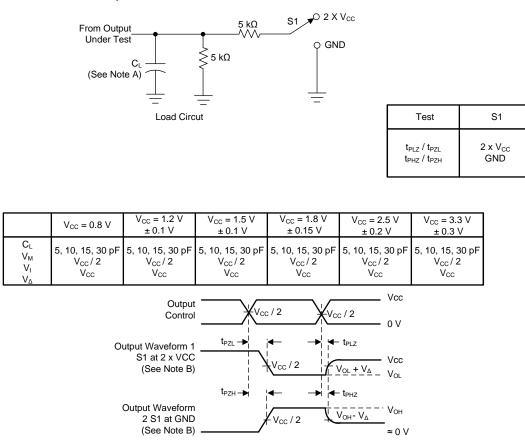
D.  $t_{PLH}$  And  $t_{PHL}$  Are the same as  $T_{pd}$ .

E. All parameters and waveforms are not applicable in all devices.

#### Figure 2. Load Circuit and Voltage Waveforms



## 7.2 (Enable and Disable Times)



Voltage Waveforms Propagation Delay Times Inverting and Noninverting Outputs

- Notes: A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such tht the output is high, except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>0</sub>= 50  $\Omega$ , t<sub>r</sub> / t<sub>f</sub> = 3 ns
  - D. The outputs are measured one at a time, with one transmision per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G. All parameters and waveforms are not applicable to all devices.

#### Figure 3. Load Circuit and Voltage Waveforms



## 8 Detailed Description

#### 8.1 Overview

The AUP family is TI's premier solution to the industry's low-power needs in battery-powered portable applications. This family of devices is specified for low static and dynamic power consumption across the entire  $V_{CC}$  range of 0.8 V to 3.6 V, resulting in an increased battery life. This product also maintains excellent signal integrity (see Figure 7 and Figure 8).

The SN74AUP1G126 device contains one buffer gate device with output enable control and performs the Boolean function Y = A. This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs when the device is powered down. This inhibits current backflow into the device which prevents damage to the device.

To assure the high-impedance state during power up or power down, OE must be tied to GND through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

## 8.2 Functional Block Diagram

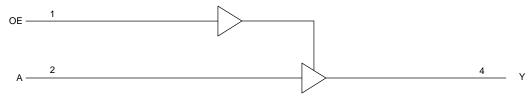


Figure 4. Logic Diagram (Positive Logic)

#### 8.3 Feature Description

#### 8.3.1 Balanced CMOS Push-Pull Outputs

A balanced output allows the device to sink and source similar currents. The drive capability of this device creates fast edges into light loads so routing and load conditions should be considered to prevent ringing. Additionally, the outputs of this device are capable of driving larger currents than the device can sustain without being damaged. It is important for the power output of the device to be limited to avoid thermal runaway and damage due to over-current. The electrical and thermal limits defined the in the *Absolute Maximum Ratings* must be followed at all times.

#### 8.3.2 Standard CMOS Inputs

Standard CMOS inputs are high impedance and are typically modelled as a resistor in parallel with the input capacitance given in the *Electrical Characteristics*. The worst case resistance is calculated with the maximum input voltage, given in the *Absolute Maximum Ratings*, and the maximum input leakage current, given in the *Electrical Characteristics*, using ohm's law ( $R = V \div I$ ).

Signals applied to the inputs must have fast edge rates, as defined by  $\Delta t/\Delta v$  in *Recommended Operating Conditions* to avoid excessive currents and oscillations. If a slow or noisy input signal is required, a device with a Schmitt-trigger input should be used to condition the input signal prior to the standard CMOS input.



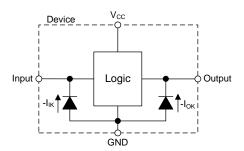
#### Feature Description (continued)

#### 8.3.3 Clamp Diodes

The inputs and outputs to this device have negative clamping diodes.

#### CAUTION

Voltages beyond the values specified in the *Absolute Maximum Ratings* table can cause damage to the device. The input negative-voltage and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.



#### Figure 5. Electrical Placement of Clamping Diodes for Each Input and Output

#### 8.3.4 Partial Power Down (I<sub>off</sub>)

The inputs and outputs for this device enter a high-impedance state when the supply voltage is 0 V. The maximum leakage into or out of any input or output pin on the device is specified by I<sub>off</sub> in the *Electrical Characteristics*.

#### 8.3.5 Overvoltage Tolerant Inputs

Input signals to this device can be driven above the supply voltage so long as they remain below the maximum input voltage value specified in the *Absolute Maximum Ratings*.

#### 8.3.6 Output Enable

This device has an output enable (OE) pin that functions according to Table 1. When the outputs of the device are disabled, they are placed into a high impedance state where it will neither source nor sink current. High-impedance outputs are also commonly referred to as three-state or tri-state outputs. The maximum leakage for the output in this state is defined by I<sub>OZ</sub> in the *Electrical Characteristics* table.

#### 8.4 Device Functional Modes

Table 1 lists the functional modes of the SN74AUP1G126 device.

| INP | INPUTS |   |  |  |  |  |  |
|-----|--------|---|--|--|--|--|--|
| OE  | OE A   |   |  |  |  |  |  |
| Н   | Н      | Н |  |  |  |  |  |
| Н   | L      | L |  |  |  |  |  |
| L   | Х      | Z |  |  |  |  |  |

#### Table 1. Function Table



## 9 Application and Implementation

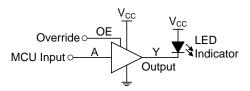
#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

#### 9.1 Application Information

The SN74AUP1G126 device is an output enabled CMOS buffer that can be used in LED indicator applications that require less than 4 mA. The device can produce up to 4 mA of drive current at 3.3 V. The inputs to the device are also overvoltage tolerant up to 3.6 V, allowing it to translate down to any valid  $V_{CC}$ .

## 9.2 Typical Application



## Figure 6. Application Schematic with MCU driving an LED Indicator

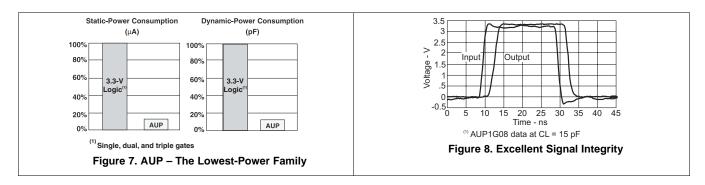
#### 9.2.1 Design Requirements

This device uses CMOS technology and has balanced output drive. Take care to avoid bus contention because it can drive currents that would exceed maximum limits. The output drive strength of this device creates fast edges into light loads so routing and load conditions should be considered to prevent ringing.

## 9.2.2 Detailed Design Procedure

- 1. Recommended Input Conditions
  - Rise time and fall time specs. See ( $\Delta t / \Delta V$ ) in the *Recommended Operating Conditions* table.
  - Specified high and low levels. See (V<sub>IH</sub> and V<sub>IL</sub>) in the *Recommended Operating Conditions* table.
  - Inputs are overvoltage tolerant allowing them to go as high as (V<sub>1</sub> max) in the *Recommended Operating Conditions* table at any valid V<sub>CC</sub>.
- 2. Recommended Output Conditions
  - Load currents should not exceed (I<sub>O</sub> max) per output and should not exceed (Continuous current through V<sub>CC</sub> or GND) total current for the part. These limits are located in the *Absolute Maximum Ratings* table.
  - Outputs should not be pulled above V<sub>CC</sub>.

## 9.2.3 Application Curves





## **10** Power Supply Recommendations

The power supply can be any voltage between the minimum and maximum supply voltage rating located in the *Recommended Operating Conditions* table.

The VCC pin must have a good bypass capacitor to prevent power disturbance. TI recommends to use a  $0.1-\mu$ F capacitor for this device. It is ok to parallel multiple bypass caps to reject different frequencies of noise.  $0.1-\mu$ F and  $1-\mu$ F capacitors are commonly used in parallel. Install the bypass capacitor as close to the power pin as possible for best results.

## 11 Layout

#### 11.1 Layout Guidelines

Even low data rate digital signals can contain high-frequency signal components due to fast edge rates. When a printed-circuit board (PCB) trace turns a corner at a 90° angle, a reflection can occur. A reflection occurs primarily because of the change of width of the trace. At the apex of the turn, the trace width increases to 1.414 times the width. This increase upsets the transmission-line characteristics, especially the distributed capacitance and self–inductance of the trace which results in the reflection. Not all PCB traces can be straight and therefore some traces must turn corners. shows progressively better techniques of rounding corners. Only the last example (BEST) maintains constant trace width and minimizes reflections.

An example layout is given in for the DPW (X2SON-5) package. This example layout includes a 0402 (metric) capacitor and uses the measurements found in the example board layout appended to this end of this datasheet. A via of diameter 0.1 mm (3.973 mil) is placed directly in the center of the device. This via can be used to trace out the center pin connection through another board layer, or it can be left out of the layout.

## 11.2 Layout Example

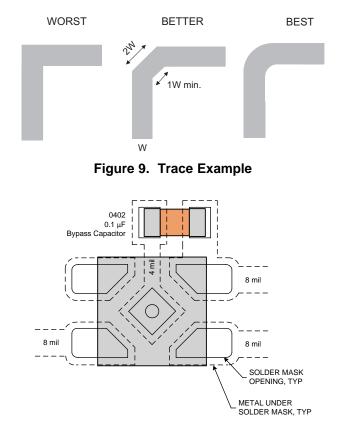


Figure 10. Example Layout With DPW (X2SON-5) Package

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## **12 Device and Documentation Support**

## **12.1** Documentation Support

#### 12.1.1 Related Documentation

For related documentation see the following:

Implications of Slow of Floating CMOS Inputs application report

## 12.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

## 12.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E<sup>™</sup> Online Community *TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

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#### 12.4 Trademarks

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#### 12.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## 12.6 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



10-Dec-2020

# PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan     | Lead finish/<br>Ball material | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5)  | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|--------------|-------------------------------|--------------------|--------------|--------------------------|---------|
|                  | (1)           |              | j                  |      | ,              | (2)          | (6)                           | (3)                |              | (4/3)                    |         |
| 74AUP1G126DRLRG4 | ACTIVE        | SOT-5X3      | DRL                | 5    | 4000           | RoHS & Green | NIPDAUAG                      | Level-1-260C-UNLIM | -40 to 85    | (HN7, HNR)               | Samples |
| SN74AUP1G126DBVR | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | H26R                     | Samples |
| SN74AUP1G126DBVT | ACTIVE        | SOT-23       | DBV                | 5    | 250            | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | H26R                     | Samples |
| SN74AUP1G126DCKR | ACTIVE        | SC70         | DCK                | 5    | 3000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | (HN5, HNF, HNK, HN<br>R) | Samples |
| SN74AUP1G126DCKT | ACTIVE        | SC70         | DCK                | 5    | 250            | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | (HN5, HNR)               | Samples |
| SN74AUP1G126DPWR | ACTIVE        | X2SON        | DPW                | 5    | 3000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | C4                       | Samples |
| SN74AUP1G126DRLR | ACTIVE        | SOT-5X3      | DRL                | 5    | 4000           | RoHS & Green | NIPDAU   NIPDAUAG             | Level-1-260C-UNLIM | -40 to 85    | (HN7, HNR)               | Samples |
| SN74AUP1G126DRYR | ACTIVE        | SON          | DRY                | 6    | 5000           | RoHS & Green | NIPDAU   NIPDAUAG             | Level-1-260C-UNLIM | -40 to 85    | HN                       | Samples |
| SN74AUP1G126DSFR | ACTIVE        | SON          | DSF                | 6    | 5000           | RoHS & Green | NIPDAU   NIPDAUAG             | Level-1-260C-UNLIM | -40 to 85    | HN                       | Samples |
| SN74AUP1G126YFPR | ACTIVE        | DSBGA        | YFP                | 6    | 3000           | RoHS & Green | SNAGCU                        | Level-1-260C-UNLIM |              | HNN                      | Samples |
| SN74AUP1G126YZPR | ACTIVE        | DSBGA        | YZP                | 5    | 3000           | RoHS & Green | SNAGCU                        | Level-1-260C-UNLIM | -40 to 85    | HNN                      | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



10-Dec-2020

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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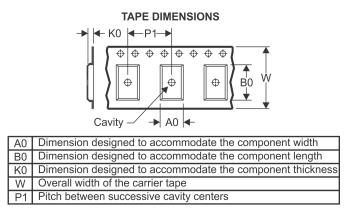
# PACKAGE MATERIALS INFORMATION

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## TAPE AND REEL INFORMATION





# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal |                 |                    |      |      |                          |                          |            |            |            |            |           |                  |
|-----------------------------|-----------------|--------------------|------|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                      | Package<br>Type | Package<br>Drawing | Pins | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| SN74AUP1G126DBVR            | SOT-23          | DBV                | 5    | 3000 | 180.0                    | 8.4                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| SN74AUP1G126DBVT            | SOT-23          | DBV                | 5    | 250  | 180.0                    | 8.4                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| SN74AUP1G126DCKR            | SC70            | DCK                | 5    | 3000 | 180.0                    | 8.4                      | 2.47       | 2.3        | 1.25       | 4.0        | 8.0       | Q3               |
| SN74AUP1G126DCKR            | SC70            | DCK                | 5    | 3000 | 178.0                    | 9.2                      | 2.4        | 2.4        | 1.22       | 4.0        | 8.0       | Q3               |
| SN74AUP1G126DCKT            | SC70            | DCK                | 5    | 250  | 178.0                    | 9.2                      | 2.4        | 2.4        | 1.22       | 4.0        | 8.0       | Q3               |
| SN74AUP1G126DCKT            | SC70            | DCK                | 5    | 250  | 180.0                    | 8.4                      | 2.47       | 2.3        | 1.25       | 4.0        | 8.0       | Q3               |
| SN74AUP1G126DPWR            | X2SON           | DPW                | 5    | 3000 | 178.0                    | 8.4                      | 0.91       | 0.91       | 0.5        | 2.0        | 8.0       | Q3               |
| SN74AUP1G126DRLR            | SOT-5X3         | DRL                | 5    | 4000 | 180.0                    | 8.4                      | 1.98       | 1.78       | 0.69       | 4.0        | 8.0       | Q3               |
| SN74AUP1G126DRLR            | SOT-5X3         | DRL                | 5    | 4000 | 180.0                    | 9.5                      | 1.78       | 1.78       | 0.69       | 4.0        | 8.0       | Q3               |
| SN74AUP1G126DRYR            | SON             | DRY                | 6    | 5000 | 180.0                    | 9.5                      | 1.15       | 1.6        | 0.75       | 4.0        | 8.0       | Q1               |
| SN74AUP1G126DRYR            | SON             | DRY                | 6    | 5000 | 180.0                    | 8.4                      | 1.25       | 1.6        | 0.7        | 4.0        | 8.0       | Q1               |
| SN74AUP1G126DSFR            | SON             | DSF                | 6    | 5000 | 180.0                    | 9.5                      | 1.16       | 1.16       | 0.5        | 4.0        | 8.0       | Q2               |
| SN74AUP1G126YFPR            | DSBGA           | YFP                | 6    | 3000 | 178.0                    | 9.2                      | 0.89       | 1.29       | 0.62       | 4.0        | 8.0       | Q1               |
| SN74AUP1G126YZPR            | DSBGA           | YZP                | 5    | 3000 | 178.0                    | 9.2                      | 1.02       | 1.52       | 0.63       | 4.0        | 8.0       | Q1               |

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# PACKAGE MATERIALS INFORMATION

30-Dec-2020



| *All dimensions are nominal |              |                 |      |      |             |            |             |
|-----------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device                      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
| SN74AUP1G126DBVR            | SOT-23       | DBV             | 5    | 3000 | 202.0       | 201.0      | 28.0        |
| SN74AUP1G126DBVT            | SOT-23       | DBV             | 5    | 250  | 202.0       | 201.0      | 28.0        |
| SN74AUP1G126DCKR            | SC70         | DCK             | 5    | 3000 | 202.0       | 201.0      | 28.0        |
| SN74AUP1G126DCKR            | SC70         | DCK             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74AUP1G126DCKT            | SC70         | DCK             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| SN74AUP1G126DCKT            | SC70         | DCK             | 5    | 250  | 202.0       | 201.0      | 28.0        |
| SN74AUP1G126DPWR            | X2SON        | DPW             | 5    | 3000 | 205.0       | 200.0      | 33.0        |
| SN74AUP1G126DRLR            | SOT-5X3      | DRL             | 5    | 4000 | 202.0       | 201.0      | 28.0        |
| SN74AUP1G126DRLR            | SOT-5X3      | DRL             | 5    | 4000 | 184.0       | 184.0      | 19.0        |
| SN74AUP1G126DRYR            | SON          | DRY             | 6    | 5000 | 184.0       | 184.0      | 19.0        |
| SN74AUP1G126DRYR            | SON          | DRY             | 6    | 5000 | 202.0       | 201.0      | 28.0        |
| SN74AUP1G126DSFR            | SON          | DSF             | 6    | 5000 | 184.0       | 184.0      | 19.0        |
| SN74AUP1G126YFPR            | DSBGA        | YFP             | 6    | 3000 | 220.0       | 220.0      | 35.0        |
| SN74AUP1G126YZPR            | DSBGA        | YZP             | 5    | 3000 | 220.0       | 220.0      | 35.0        |

# **DBV0005A**



# **PACKAGE OUTLINE**

# SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. Refernce JEDEC MO-178.

- 4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.



# DBV0005A

# **EXAMPLE BOARD LAYOUT**

# SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# DBV0005A

# **EXAMPLE STENCIL DESIGN**

# SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

8. Board assembly site may have different recommendations for stencil design.



DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES: A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - D. Falls within JEDEC MO-203 variation AA.



# LAND PATTERN DATA



NOTES:

- A. All linear dimensions are in millimeters.B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



# **DRL0005A**



# **PACKAGE OUTLINE**

# SOT - 0.6 mm max height

PLASTIC SMALL OUTLINE



- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side. 4. Reference JEDEC registration MO-293 Variation UAAD-1



# DRL0005A

# **EXAMPLE BOARD LAYOUT**

# SOT - 0.6 mm max height

PLASTIC SMALL OUTLINE



NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# **DRL0005A**

# **EXAMPLE STENCIL DESIGN**

# SOT - 0.6 mm max height

PLASTIC SMALL OUTLINE



NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

8. Board assembly site may have different recommendations for stencil design.



# **GENERIC PACKAGE VIEW**

# USON - 0.6 mm max height PLASTIC SMALL OUTLINE - NO LEAD



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



4207181/G

# **DRY0006A**



# **PACKAGE OUTLINE**

# USON - 0.6 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice.



# DRY0006A

# **EXAMPLE BOARD LAYOUT**

# USON - 0.6 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

3. For more information, see QFN/SON PCB application report in literature No. SLUA271 (www.ti.com/lit/slua271).



# DRY0006A

# **EXAMPLE STENCIL DESIGN**

# USON - 0.6 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



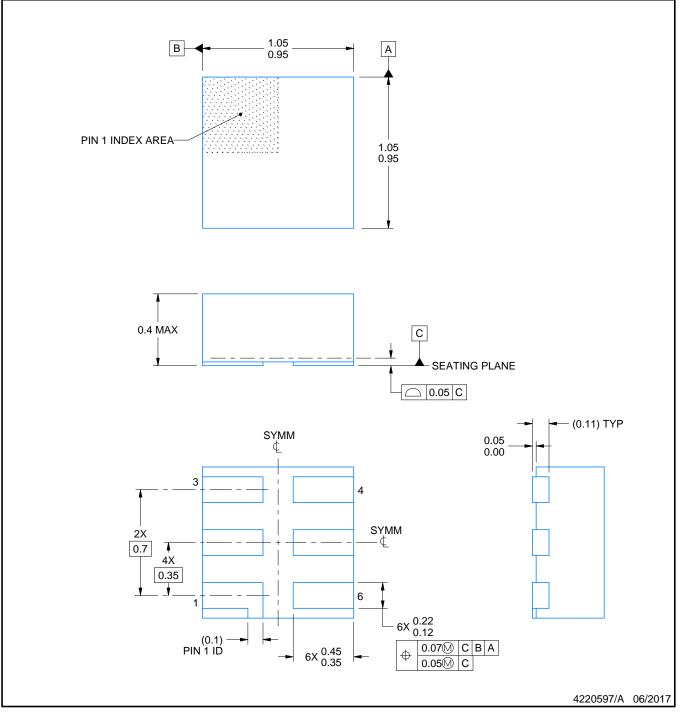
# **DSF0006A**



# **PACKAGE OUTLINE**

# X2SON - 0.4 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing Per ASME Y14.5M.
  This drawing is subject to change without notice.
  Reference JEDEC registration MO-287, variation X2AAF.

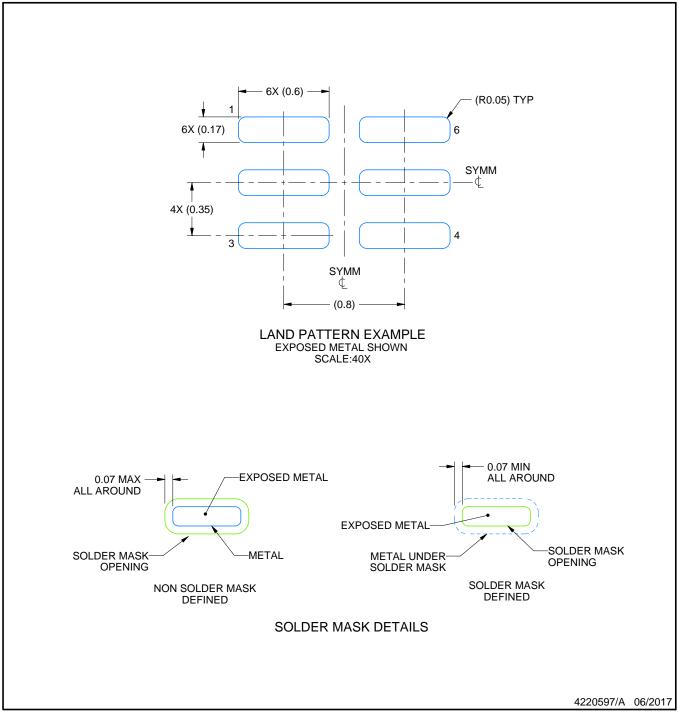


# **DSF0006A**

# **EXAMPLE BOARD LAYOUT**

# X2SON - 0.4 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

4. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).



#### **DSF0006A**

## **EXAMPLE STENCIL DESIGN**

#### X2SON - 0.4 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



#### **GENERIC PACKAGE VIEW**

# X2SON - 0.4 mm max height PLASTIC SMALL OUTLINE - NO LEAD



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



4211218-3/D

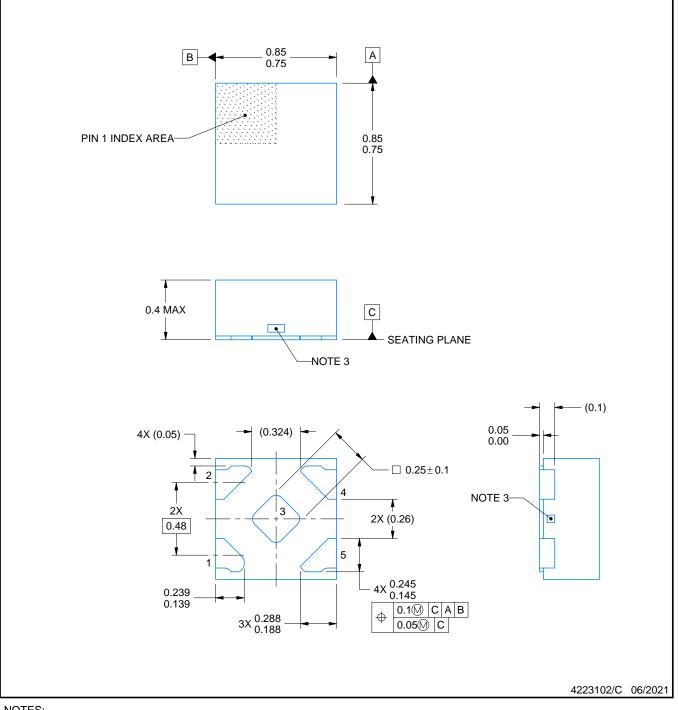
### **DPW0005A**



#### **PACKAGE OUTLINE**

#### X2SON - 0.4 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. The size and shape of this feature may vary.

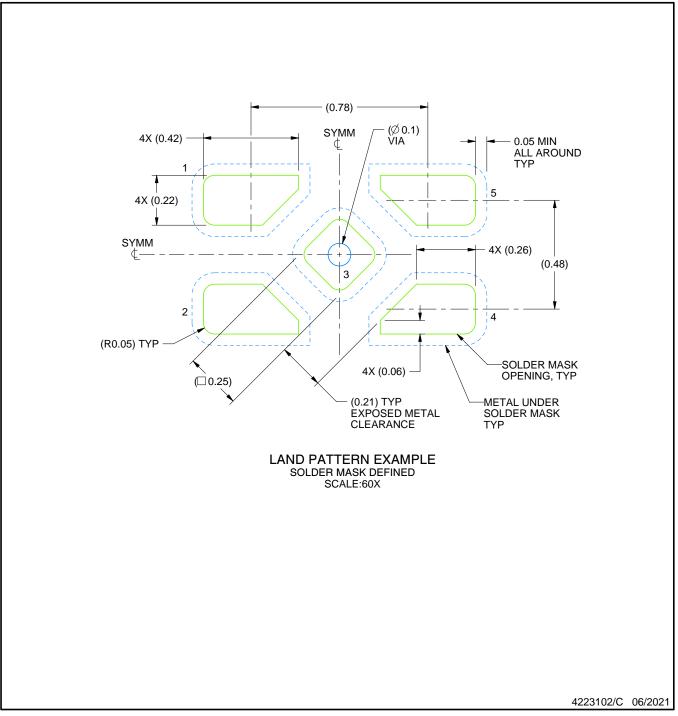


#### **DPW0005A**

### **EXAMPLE BOARD LAYOUT**

#### X2SON - 0.4 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, refer to QFN/SON PCB application note in literature No. SLUA271 (www.ti.com/lit/slua271).

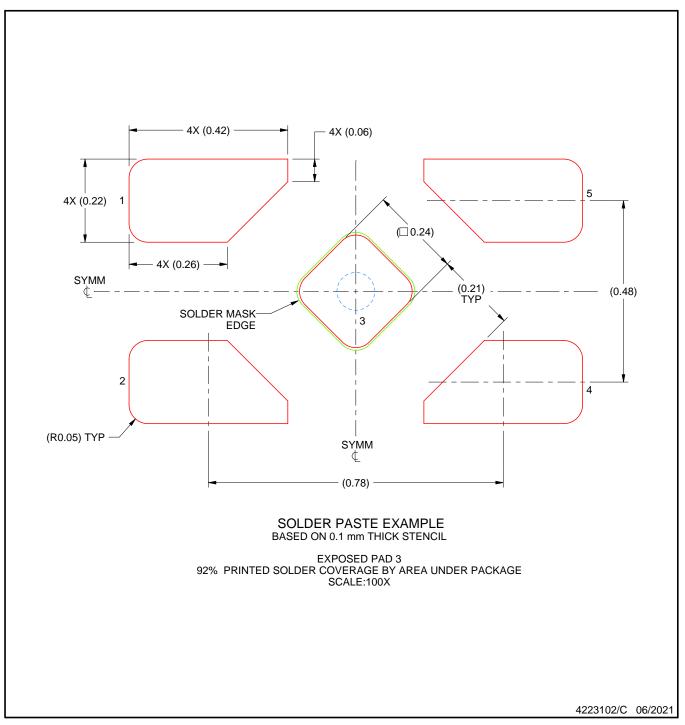


#### DPW0005A

### **EXAMPLE STENCIL DESIGN**

#### X2SON - 0.4 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



# YZP0005



#### **PACKAGE OUTLINE**

#### DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.



### YZP0005

## **EXAMPLE BOARD LAYOUT**

#### DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



NOTES: (continued)

3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SNVA009 (www.ti.com/lit/snva009).



## YZP0005

# **EXAMPLE STENCIL DESIGN**

#### DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



### **YFP0006**



#### **PACKAGE OUTLINE**

#### DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice.



#### YFP0006

### **EXAMPLE BOARD LAYOUT**

#### DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



NOTES: (continued)

3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SNVA009 (www.ti.com/lit/snva009).



### YFP0006

## **EXAMPLE STENCIL DESIGN**

#### DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



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